

PIM IGBT Module

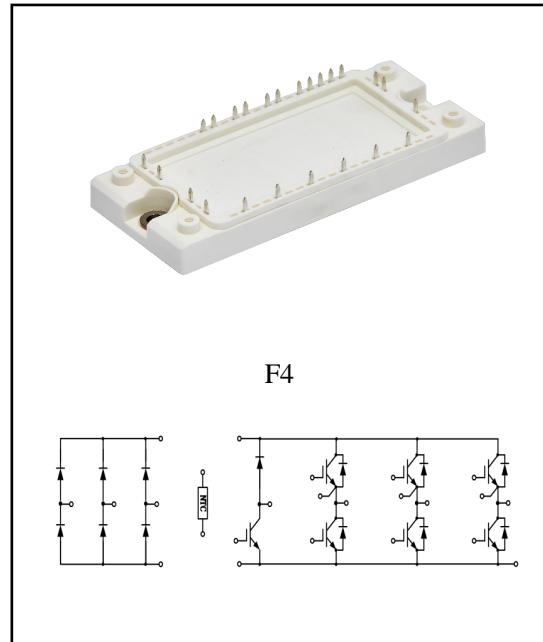
$V_{CES}=1200V$, $I_C \text{ nom}=25A$ / $I_{CRM}=50A$

Electrical characteristics :

- 1200V Trench /Field Stop process
- Low switching losses
- V_{cesat} has a positive temperature coefficient

Applications:

- Variable Frequency Drive
- Servo drive
- Inverter



IGBT, Inverter

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Collector-Emitter voltage	$T_{vj}=25^\circ C$	V_{CES}	1200	V
Continuous DC collector current	$T_C=100^\circ C$, $T_{vj \max}=175^\circ C$	$I_C \text{ nom}$	25	A
Repetitive peak collector current	$t_p=1 \text{ ms}$	I_{CRM}	50	A
Total power dissipation	$T_C = 25^\circ C$, $T_{vj \max} = 175^\circ C$	P_{tot}	187	W
Gate emitter voltage		V_{GE}	± 20	V

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	$V_{GE}=15V$, $I_C=25A$ $T_{vj}=25^\circ C$ $V_{GE}=15V$, $I_C=25A$ $T_{vj}=125^\circ C$ $V_{GE}=15V$, $I_C=25A$ $T_{vj}=150^\circ C$	V_{CEsat}		1.65 1.93 2.00	2.05	V

Gate-Emitter threshold voltage	$I_C=1\text{mA}$, $V_{GE}=V_{CE}$	$T_{vj}=25^\circ\text{C}$	$V_{GE(\text{th})}$	5.0	5.6	6.20	
Internal gate resistor			R_{Gint}		None		Ω
Input capacitance	$f=1\text{MHz}$, $V_{CE}=25\text{V}$, $V_{GE}=0\text{V}$	$T_{vj}=25^\circ\text{C}$	C_{ies}		1.66		nF
Reverse transfer capacitance			C_{res}		0.08		
Collector-emitter cut-off current	$V_{CE}=1200\text{V}$, $V_{GE}=0\text{V}$	$T_{vj}=25^\circ\text{C}$	I_{CES}			1	mA
Gate-emitter leakage current	$V_{CE}=0\text{V}$, $V_{GE}=20\text{V}$	$T_{vj}=25^\circ\text{C}$	I_{GES}			100	nA
Turn-on delay time	$I_C=25\text{A}$, $V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}$, $R_G=40\Omega$ (inductive load)	$T_{vj}=25^\circ\text{C}$ $T_{vj}=125^\circ\text{C}$ $T_{vj}=150^\circ\text{C}$	$t_{d\text{ on}}$		67 58 60		ns
Rise time	$I_C=25\text{A}$, $V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}$, $R_G=40\Omega$ (inductive load)	$T_{vj}=25^\circ\text{C}$ $T_{vj}=125^\circ\text{C}$ $T_{vj}=150^\circ\text{C}$	t_r		46 56 55		
Turn-off delay time	$I_C=25\text{A}$, $V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}$, $R_G=40\Omega$ (inductive load)	$T_{vj}=25^\circ\text{C}$ $T_{vj}=125^\circ\text{C}$ $T_{vj}=150^\circ\text{C}$	$t_{d\text{ off}}$		311 347 360		
Fall time	$I_C=25\text{A}$, $V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}$, $R_G=40\Omega$ (inductive load)	$T_{vj}=25^\circ\text{C}$ $T_{vj}=125^\circ\text{C}$ $T_{vj}=150^\circ\text{C}$	t_f		202 274 288		
Turn-on energy loss per pulse	$I_C=25\text{A}$, $V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}$, $R_G=40\Omega$ (inductive load)	$T_{vj}=25^\circ\text{C}$ $T_{vj}=125^\circ\text{C}$ $T_{vj}=150^\circ\text{C}$	E_{on}		2.74 3.95 4.46		mJ
Turn-off energy loss per pulse	$I_C=25\text{A}$, $V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}$, $R_G=40\Omega$ (inductive load)	$T_{vj}=25^\circ\text{C}$ $T_{vj}=125^\circ\text{C}$ $T_{vj}=150^\circ\text{C}$	E_{off}		1.71 2.15 2.36		
SC data	$V_{GE}\leq 15\text{V}$, $V_{CC}=800\text{V}$ $V_{CEmax}=V_{CES}-L_{sCE}\cdot di/dt$ $t_p\leq 8\mu\text{s}$, $T_{vj}=150^\circ\text{C}$		I_{SC}		125		A
Thermal resistance, junction to case	per IGBT		R_{thJC}			0.80	K/W
Temperature under switching conditions			$T_{vj\text{ op}}$	-40		150	$^\circ\text{C}$

Diode, Inverter

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Repetitive peak reverse voltage	$T_{vj}=25^\circ\text{C}$	V_{RRM}	1200	V
Continuous DC forward current		I_F	25	A
Repetitive peak forward current	$t_p=1\text{ms}$	I_{FRM}	50	A

I ² t-value	t _p =10ms, sin180° , T _j =125°C	I ² t	200	A ² s
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Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	I _F =25A, V _{GE} =0V	T _{vj} =25°C	V _F	1.85	2.40	V
	I _F =25A, V _{GE} =0V	T _{vj} =125°C			1.54	
	I _F =25A, V _{GE} =0V	T _{vj} =150°C			1.46	
Peak reverse recovery current	I _F =25A,	T _{vj} =25°C	I _{RM}	19	25	A
	-dI/dt=464A/μs(T _{vj} =150°C)	T _{vj} =125°C			28	
	V _R =600V, V _{GE} =-15V	T _{vj} =150°C				
Recovered charge	I _F =25A,	T _{vj} =25°C	Q _r	1.93	4.83	μC
	-dI/dt=464A/μs(T _{vj} =150°C)	T _{vj} =125°C			5.79	
	V _R =600V, V _{GE} =-15V	T _{vj} =150°C				
Reverse recovered energy	I _F =25A,	T _{vj} =25°C	E _{rec}	0.63	1.57	mJ
	-dI/dt=464A/μs(T _{vj} =150°C)	T _{vj} =125°C			1.90	
	V _R =600V, V _{GE} =-15V	T _{vj} =150°C				
Thermal resistance, junction to case	per diode	R _{thJC}			1.35	K/W
Temperature under switching conditions		T _{vj op}	-40		150	°C

Diode, Rectifier

Maximum Ratings

Parameter	Conditions	Symbol	Value			Unit
Repetitive peak reverse voltage	T _{vj} =25°C	V _{RRM}	1600			V
Non-Repetitive peak reverse voltage	T _{vj} =25°C	V _{RSM}	1800			V
Maximum Average Forward Current		I _{F(AV)}	25			A
Surge forward current	t _p =10ms, sin180° , T _{vj} =25°C	I _{FSM}	320			A
I ² t-value	t _p =10ms, sin180° , T _{vj} =25°C	I ² t	512			A ² s

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	I _F =25A, T _{vj} =25°C	V _F			1.1	V

Reverse current	$V_R = V_{RRM}$	$T_{vj} = 25^\circ C$	I_R			5	μA
Temperature under switching conditions			$T_{vj \text{ op}}$	-40		150	$^\circ C$

IGBT, Brake-Chopper

Maximum Ratings

Parameter	Conditions	Symbol	Value		Unit
Collector-Emitter voltage	$T_{vj} = 25^\circ C$	V_{CES}	1200		V
Continuous DC collector current	$T_C = 100^\circ C, T_{vj \text{ max}} = 175^\circ C$	$I_{C \text{ nom}}$	25		A
Repetitive peak collector current	$t_p = 1 \text{ ms}$	I_{CRM}	50		A
Total power dissipation	$T_C = 25^\circ C, T_{vj \text{ max}} = 175^\circ C$	P_{tot}	125		W
Gate emitter voltage		V_{GE}	± 20		V

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	$V_{GE} = 15V, I_c = 25A$	V_{CEsat}	1.81	2.20		V
	$V_{GE} = 15V, I_c = 25A$					
	$V_{GE} = 15V, I_c = 25A$					
Gate-Emitter threshold voltage	$I_c = 1mA, V_{GE} = V_{CE}$	$V_{GE(th)}$	5.10	5.68	6.30	
Internal gate resistor		R_{Gint}		None		Ω
Input capacitance	$f = 1MHz, V_{CE} = 25 V, V_{GE} = 0 V$	C_{ies}	1.66			nF
Reverse transfer capacitance		C_{res}				
Collector-emitter cut-off current	$V_{CE} = 1200V, V_{GE} = 0 V$	I_{CES}			1	mA
Gate-emitter leakage current	$V_{CE} = 0 V, V_{GE} = 20 V$	I_{GES}			100	nA
Turn-on delay time	$I_c = 25A, V_{CE} = 600 V$	$t_{d \text{ on}}$	69			ns
	$V_{GE} = \pm 15 V, R_g = 40\Omega$					
	(inductive load)					
Rise time	$I_c = 25A, V_{CE} = 600 V$	t_r	69			
	$V_{GE} = \pm 15 V, R_g = 40\Omega$					
	(inductive load)					

Turn-off delay time	I _C =25A, V _{CE} =600 V V _{GE} =±15 V, R _G =40Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _{d off}		299 351 361	
Fall time	I _C =25A, V _{CE} =600 V V _{GE} =±15 V, R _G =40Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _f		224 299 309	
Turn-on energy loss per pulse	I _C =25A, V _{CE} =600 V V _{GE} =±15 V, R _G =40Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	E _{on}		2.01 2.48 2.68	mJ
Turn-off energy loss per pulse	I _C =25A, V _{CE} =600 V V _{GE} =±15 V, R _G =40Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C		E _{off}	1.59 2.14 2.26	
Thermal resistance, junction to case	per IGBT		R _{thJC}			1.2 K/W
Temperature under switching conditions			T _{vj op}	-40		150 °C

Diode, Brake-Chopper

Maximum Ratings

Parameter	Conditions	Symbol	Value		Unit
Repetitive peak reverse voltage	T _{vj} =25°C	V _{RRM}	1200		V
Continuous DC forward current		I _F	8		A
Repetitive peak forward current	t _p =1ms	I _{FRM}	16		A
I ² t-value	V _R =0V, t _p =10ms, T _{vj} =125 °C	I ² t	24		A ² s

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	I _F =8A, V _{GE} =0V	V _F		2.03	2.50	V
	I _F =8A, V _{GE} =0V			1.71		
	I _F =8A, V _{GE} =0V			1.64		
Peak reverse recovery current	I _F =8A, -dI/dt=254A/μs(T _{vj} =150°C)	I _{RM}	T _{vj} =25°C	8		A
			T _{vj} =125°C	12		
	V _R =600V, V _{GE} =-15V		T _{vj} =150°C	13		
Recovered charge	I _F =8A, -dI/dt=254A/μs(T _{vj} =150°C)	Q _r	T _{vj} =25°C	0.23		μC
			T _{vj} =125°C	1.16		
	V _R =600V, V _{GE} =-15V		T _{vj} =150°C	1.30		
Reverse recovered energy	I _F =8A, -dI/dt=254A/μs(T _{vj} =150°C)	E _{rec}	T _{vj} =25°C	0.03		mJ
			T _{vj} =125°C	0.36		
	V _R =600V, V _{GE} =-15V		T _{vj} =150°C	0.40		

Thermal resistance, junction to case	per diode	R _{thJC}			2.30	K/W
Temperature under switching conditions		T _{vj op}	-40		150	°C

NTC-Thermistor

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Rated resistances	T _c =25°C, ±5%	R ₂₅		5.0		kΩ
B-value	±1%	B _{25/50}		3380		K

Module

Parameter	Conditions	Symbol	Value			Unit
Isolation test voltage	RMS, f=50Hz, t=1min	V _{ISOL}	2500			V
Internal isolation			Al ₂ O ₃			
Storage temperature		T _{stg}	-40		125	°C
Mounting torque for modul mounting		M	3.0		6.0	Nm
Weight		W		170		g

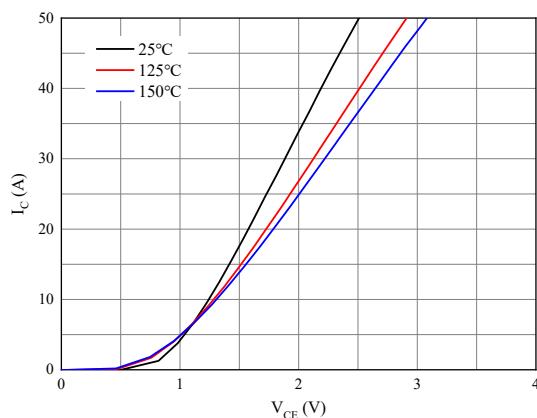


Fig 1. Typical output characteristics ($V_{GE}=15V$)

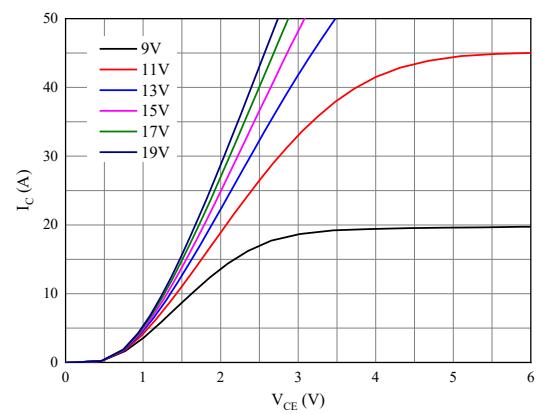


Fig 2. Typical output characteristics ($T_{vj}=150^{\circ}C$)

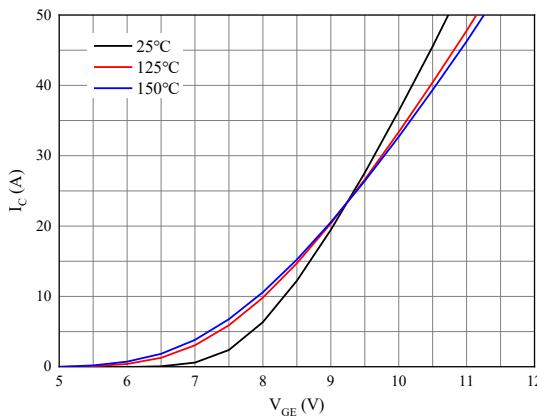


Fig 3. Typical transfer characteristic($V_{CE}=20V$)

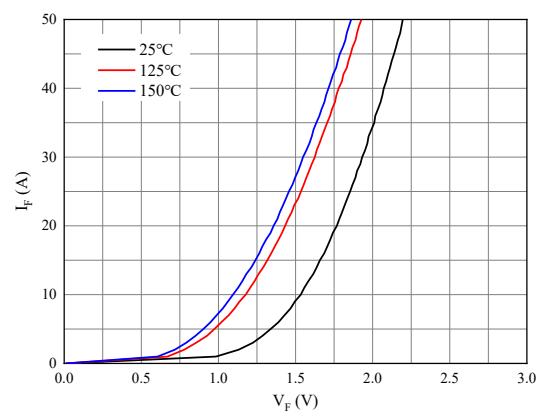


Fig 4. Forward characteristic of Diode

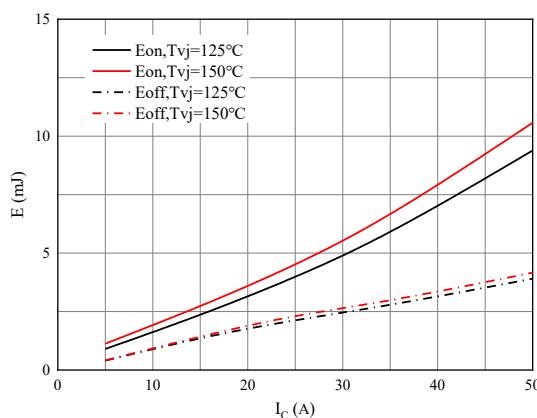


Fig 5. Switching losses of IGBT

$V_{GE}=\pm 15V$, $R_{Gon}=40\Omega$, $R_{Goff}=40\Omega$, $V_{CE}=600V$

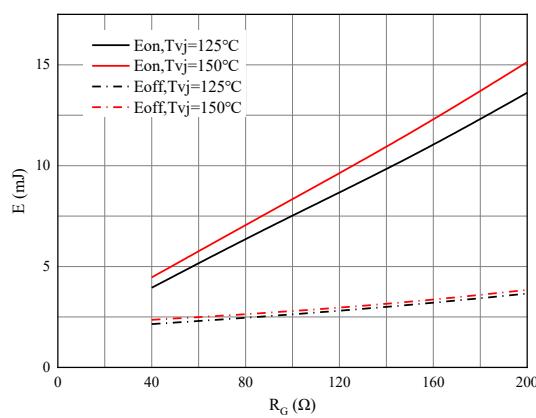


Fig 6. Switching losses of IGBT

$V_{GE}=\pm 15V$, $I_C=25A$, $V_{CE}=600V$

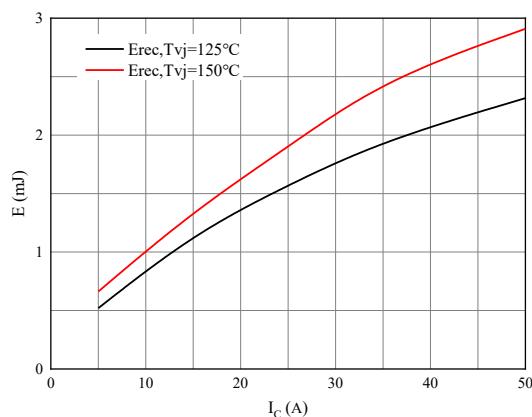


Fig 7. Switching losses of Diode
R_{Gon}=40Ω, V_{CE}=600V

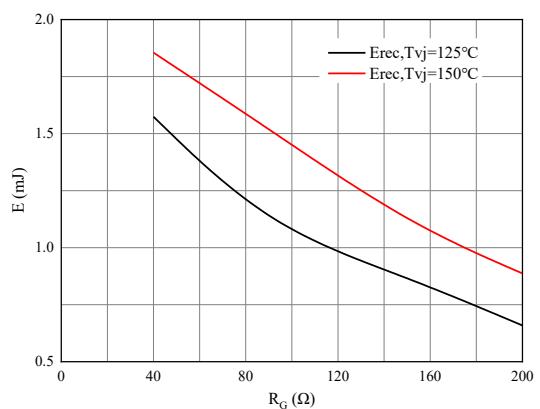


Fig 8. Switching losses of Diode
I_F=25A, V_{CE}=600V

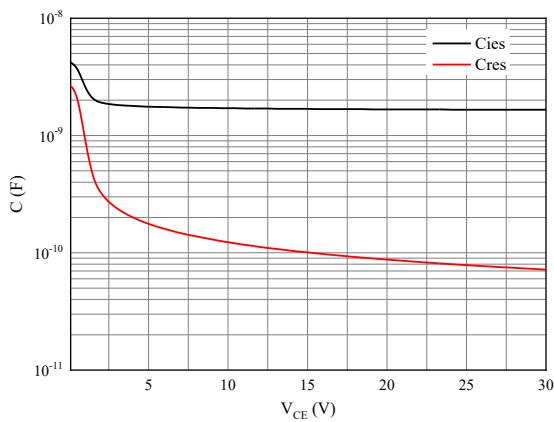


Fig 9. Capacitance characteristic

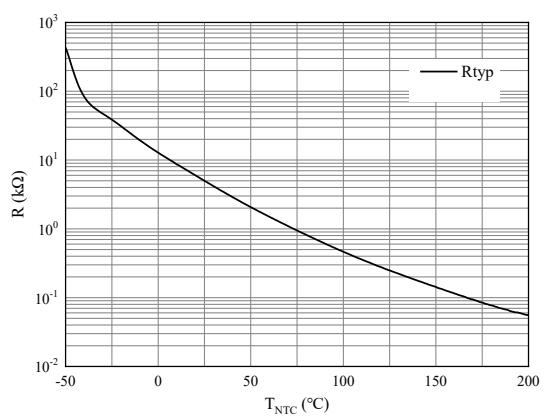
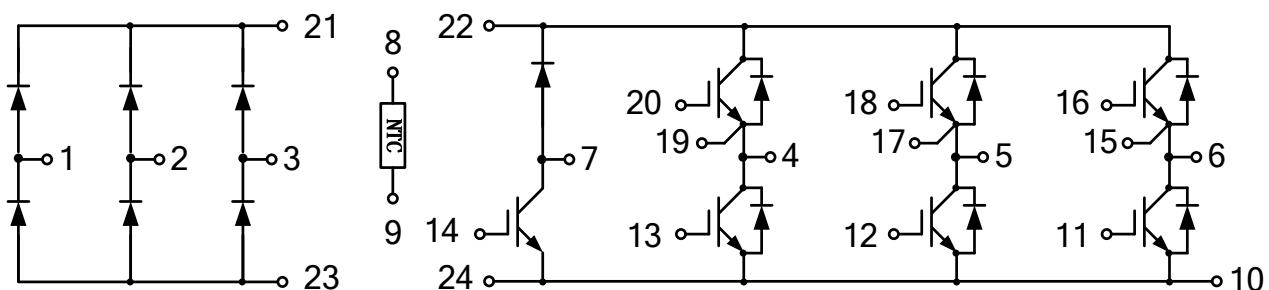


Fig 10. NTC-Thermistor-temperature characteristic

Circuit diagram

Package outlines
